## SiR428DP

# Vishay Siliconix



<b>SPECIFICATIONS</b> $T_J = 25  ^{\circ}C$ , Parameter	1	Test Conditions	Min.	Tren	Max.	Unit
Static	Symbol	rest Conditions	IVIIII.	Тур.	IVIAX.	Ollit
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	1	<u> </u>	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		27		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 4.4		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	1.2	7.7	2.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V, } V_{GS} = \pm 20 \text{ V}$	1.2		± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 20 \text{ V}$			1	μА
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$		0.0061	0.0075	Ω
		$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		0.0077	0.0095	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		46		S
Dynamic <sup>b</sup>	<u>'</u>			•	•	L
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1117		pF
Output Capacitance	C <sub>oss</sub>			274		
Reverse Transfer Capacitance	C <sub>rss</sub>			80		
Total Gate Charge	$Q_g$	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$ $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		21	32	nC
	_			9.5	14.5	
Gate-Source Charge	Q <sub>gs</sub>			2.8		
Gate-Drain Charge	Q <sub>gd</sub>			2.8		
Gate Resistance	$R_g$	f = 1 MHz	0.2	0.5	1.0	Ω
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 15 \text{ V, } R_L = 1.5 \ \Omega$ $I_D \cong 10 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 1 \ \Omega$		8	16	ns
Rise Time	t <sub>r</sub>			10	20	
Turn-Off Delay Time	t <sub>d(off)</sub>			17	34	
Fall Time	t <sub>f</sub>			8	16	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 10 \text{ V},  R_L = 1  \Omega$ $I_D \cong 10 \text{ A},  V_{GEN} = 4.5 \text{ V},  R_g = 1  \Omega$		16	32	
Rise Time	t <sub>r</sub>			11	22	
Turn-Off Delay Time	t <sub>d(off)</sub>			18	36	
Fall Time	t <sub>f</sub>			9	18	
<b>Drain-Source Body Diode Characteristic</b>	cs					
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C		30	Α	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				60	_ ^
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 3 A		0.75	1.1	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$I_F$ = 10 A, dI/dt = 100 A/ $\mu$ s, $T_J$ = 25 °C		22	40	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			15.5	28	nC
Reverse Recovery Fall Time	t <sub>a</sub>			14		ns
Reverse Recovery Rise Time	t <sub>b</sub>			8	1	

#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

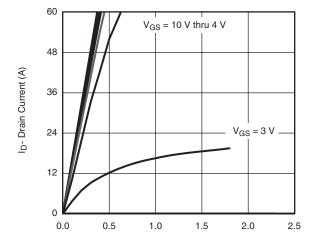
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





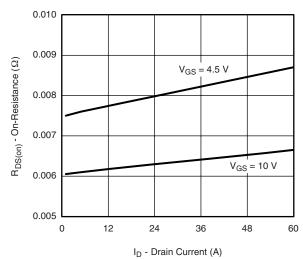
# Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

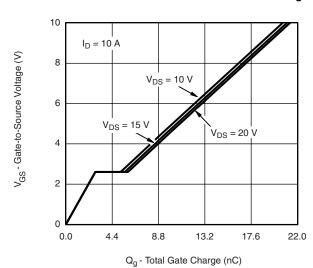


V<sub>DS</sub> - Drain-to-Source Voltage (V)





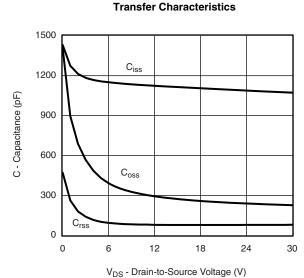
On-Resistance vs. Drain Current and Gate Voltage



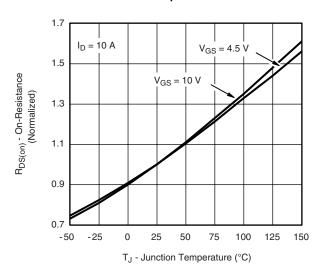
**Gate Charge** 

10 8 I<sub>D</sub> - Drain Current (A) 6 T<sub>C</sub> = 125 °C T<sub>C</sub> = 25 °C 2 T<sub>C</sub> = - 55 0 0

V<sub>GS</sub> - Gate-to-Source Voltage (V)



#### Capacitance



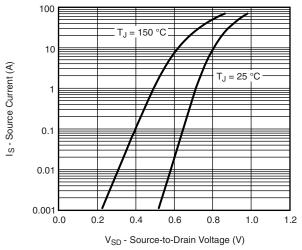
On-Resistance vs. Junction Temperature

## SiR428DP

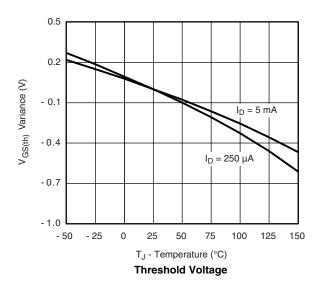
# Vishay Siliconix

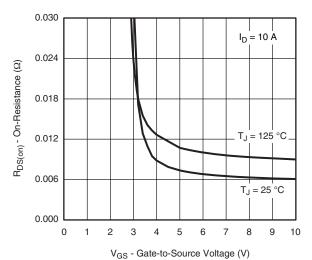
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

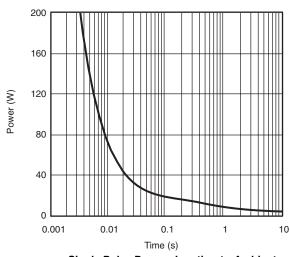


#### Source-Drain Diode Forward Voltage

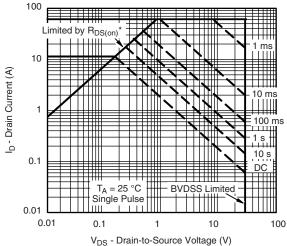




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



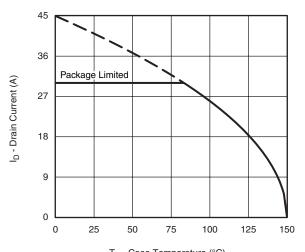
\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient



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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



 $\mathrm{T}_{\mathrm{C}}$  - Case Temperature (°C)

2.5

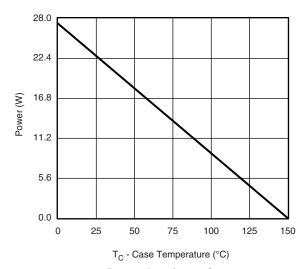
2.0

1.5

1.0

Power (W)

#### **Current Derating\***





T<sub>A</sub> - Ambient Temperature (°C)

Power, Junction-to-Case

Power, Junction-to-Ambient

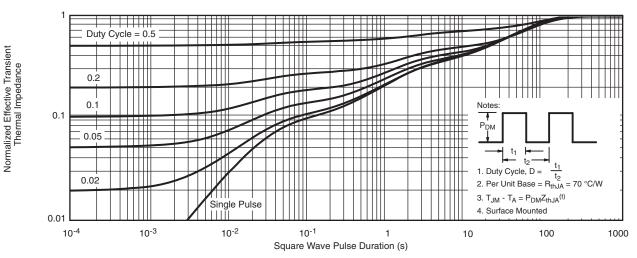
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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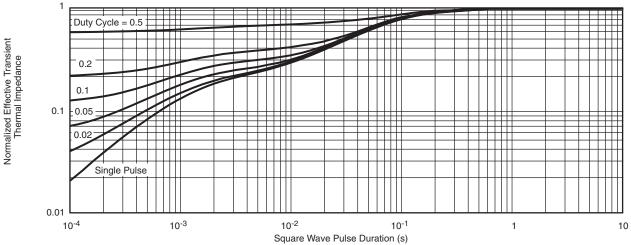
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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